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Silicon N-Channel MOS FET



ADE-208-1288 (Z) 1st. Edition Mar. 2001

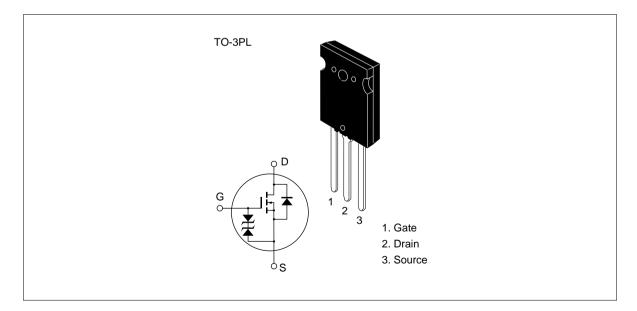
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- Built-in fast recovery diode ($t_{rr} = 120 \text{ ns}$)
- Suitable for motor control, switching regulator, DC-DC converter

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1519	V _{DSS}	450	V
	2SK1520		500	
Gate to source voltage		V _{GSS}	±30	V
Drain current		I _D	30	A
Drain peak current		L _{D(pulse)} *1	120	A
Body to drain diode reverse drain current		I _{DR}	30	А
Channel dissipation		Pch*2	200	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

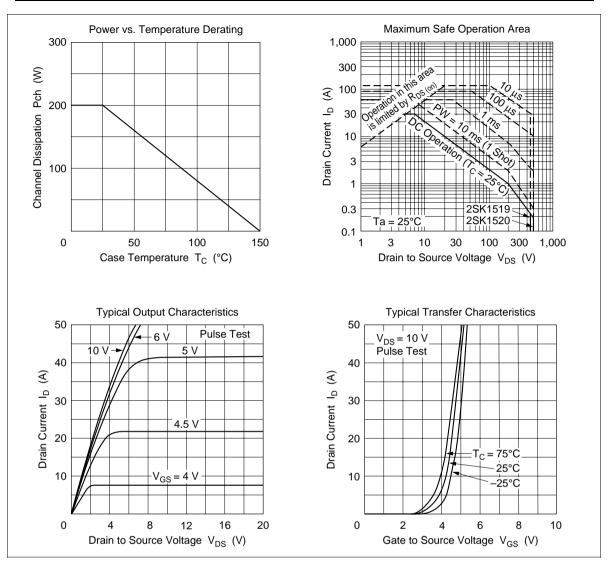
Notes: 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

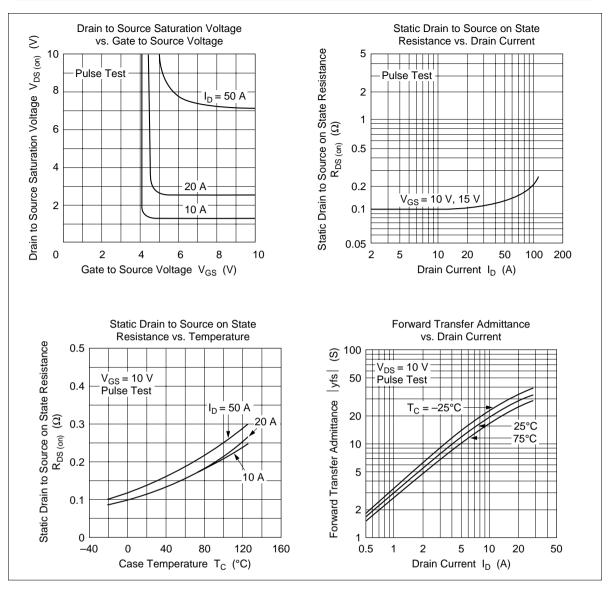
2. Value at $T_c = 25^{\circ}C$

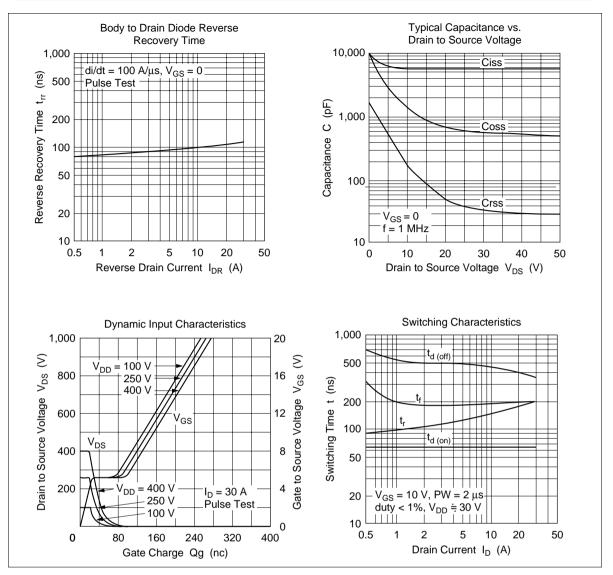
		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	2SK1519	$V_{(\text{BR})\text{DSS}}$	450	—	_	V	$I_{\rm D} = 10 \text{ mA}, V_{\rm GS} = 0$
breakdown voltage	2SK1520	-	500	-			
Gate to source break	down	$V_{(\text{BR})\text{GSS}}$	±30	_	_	V	$I_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak c	urrent	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 25 \text{ V}, \text{ V}_{DS} = 0$
Zero gate voltage	2SK1519	I _{DSS}	_	_	250	μA	$V_{\rm DS} = 360$ V, $V_{\rm GS} = 0$
drain current	2SK1520	-					$V_{\rm DS} = 400 \text{ V}, \text{ V}_{\rm GS} = 0$
Gate to source cutoff	voltage	$V_{\text{GS(off)}}$	2.0	—	3.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
Static Drain to source	2SK1519		—	0.11	0.15	Ω	$I_{\rm D} = 15$ A, $V_{\rm GS} = 10$ V *1
on state resistance	2SK1520	-	_	0.12	0.16	-	
Forward transfer adm	ittance	yfs	15	25	_	S	$I_{\rm D} = 15$ A, $V_{\rm DS} = 10$ V *1
Input capacitance		Ciss	_	5800	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance		Coss	—	1550		pF	f = 1 MHz
Reverse transfer capa	acitance	Crss	_	170	_	pF	
Turn-on delay time		t _{d(on)}	—	65	_	ns	$I_{\rm D} = 15$ A, $V_{\rm GS} = 10$ V,
Rise time		t,	_	170	_	ns	$R_{L} = 2 \Omega$
Turn-off delay time		t _{d(off)}	_	415		ns	
Fall time		t _f	_	200	—	ns	-
Body to drain diode fo voltage	orward	V_{DF}	_	1.1	—	V	$I_{\rm F} = 30$ A, $V_{\rm GS} = 0$
Body to drain diode re recovery time	everse	t _{rr}	—	120	—	ns	$I_{F} = 30 \text{ A}, V_{GS} = 0,$ $di_{F}/dt = 100 \text{ A}/\mu\text{s}$

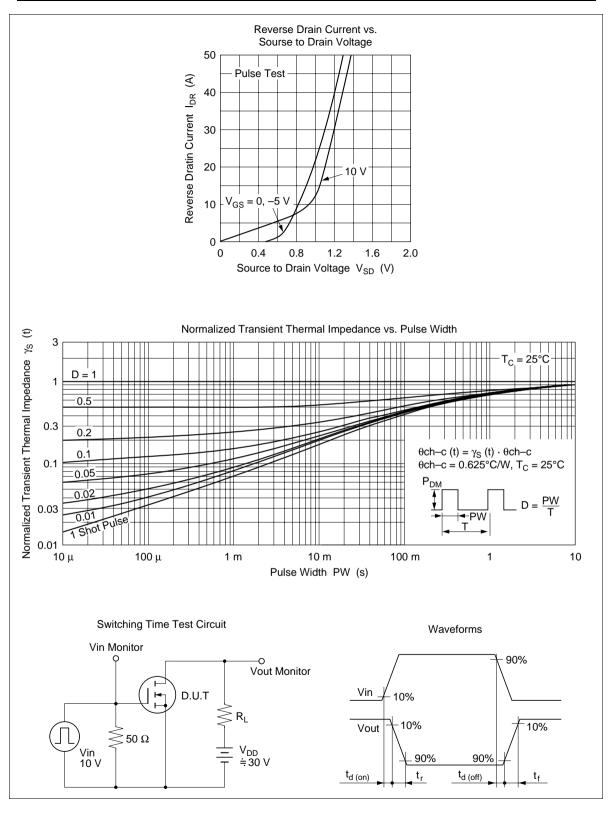
Electrical Characteristics (Ta = 25° C)

Note: 1. Pulse test



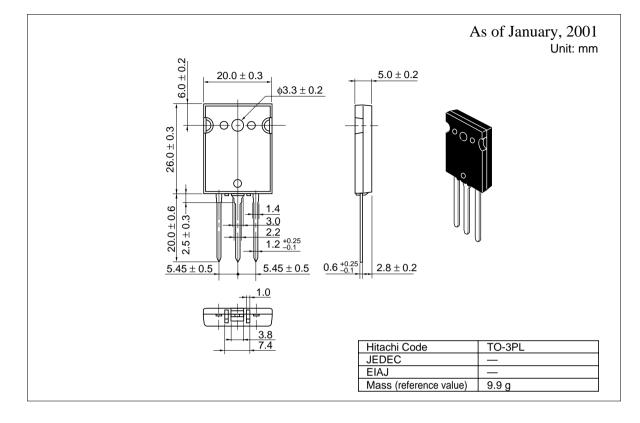






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Package Dimensions



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